

IIT Guwahati Technology Innovation and Development Foundation

Guwahati-781039, Assam

Applications are invited for the interview against Post-Doctoral Fellow position in NMICPS Sponsored **TIH (Technology Innovation Hub) on Technology for Underwater Exploration**, IIT Guwahati, Technology Innovation and Development Foundation (TIDF).

Date: To be announced

Time: To be announced

Online: Google Meet / Skype

| Sl No. | Project Staff Designation | Number of Vacancies | Consolidated Recommended Pay | Duration of Appointment in months | Qualifications |
|--------|----------------------------|---------------------|------------------------------|--|---|
| 1 | Post Doc (ME/Mechatronics) | 3 | ₹ 60,000 | 11 months (can be extended up to 3 years based on performance) | PhD degree in ME/Mechatronics Engineering. Experience in the field of Structural Analysis, Sensor and Actuator Development for Underwater Application. |
| 2 | Post Doc (CSE) | 1 | | | PhD degree in Computer Science and Engineering with experience in the field of Computer vision, data analysis, robotics for Underwater Exploration |
| 3 | Post Doc (ECE/EEE/EE) | 2 | | | PhD degree in ECE/EEE/EE with experience in the field of communication, controller design, PCB manufacturing, sensor development for Underwater Exploration |
| 4 | Post Doc (CE) | 1 | | | PhD degree in Civil Engineering with experience in the field of water resource and management for Underwater Exploration |

How to apply and selection process:

- Eligible candidates have to submit the CV mentioning all educational qualifications, experience etc in the portal link : <https://forms.gle/xTqKXxHvte7buQDg6> within 15.07.2022 (5:00 PM). Shortlisted candidates will be called through an E-mail for the interview. Selection will be based on the performance of the candidate in the interview. Candidates will not be sent any call letter separately.

- Mode of Interview will be communicated later.
- Candidates have to appear in the Interview (To be announced)

No TA/DA will be paid to the candidates for appearing in the interview.

Ref: IITGTIDF/TIH/22-23/Recct06